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Low-power dual inverter and single buffer

Rev. 2 — 17 January 2013

Product data sheet

1. General description

The 74AUP3G0434 is a dual inverter and single buffer.

Schmitt trigger action at all inputs makes the circuit tolerant of slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-12 (0.8 V to 1.3 V)
 - JESD8-11 (0.9 V to 1.65 V)
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \ \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78B Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Low-power dual inverter and single buffer

3. Ordering information

| Table 1. Ordering | information | | | |
|-------------------|-------------------|--------|---|----------|
| Type number | Package | | | |
| | Temperature range | Name | Description | Version |
| 74AUP3G0434DC | –40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 |
| 74AUP3G0434GT | –40 °C to +125 °C | XSON8 | plastic extremely thin small outline package; no leads; 8 terminals; body $1 \times 1.95 \times 0.5$ mm | SOT833-1 |
| 74AUP3G0434GF | –40 °C to +125 °C | XSON8 | extremely thin small outline package; no leads; 8 terminals; body $1.35 \times 1 \times 0.5$ mm | SOT1089 |
| 74AUP3G0434GD | –40 °C to +125 °C | XSON8 | plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm | SOT996-2 |
| 74AUP3G0434GM | –40 °C to +125 °C | XQFN8 | plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6 \times 1.6 \times 0.5$ mm | SOT902-2 |
| 74AUP3G0434GN | –40 °C to +125 °C | XSON8 | extremely thin small outline package; no leads; 8 terminals; body $1.2 \times 1.0 \times 0.35$ mm | SOT1116 |
| 74AUP3G0434GS | –40 °C to +125 °C | XSON8 | extremely thin small outline package; no leads; 8 terminals; body $1.35 \times 1.0 \times 0.35$ mm | SOT1203 |
| | | | | |

4. Marking

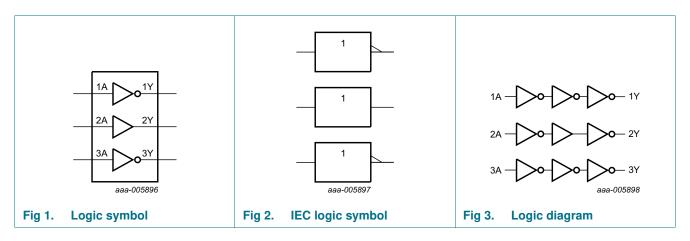
| Table 2. | Marking codes |
|----------|---------------|
|----------|---------------|

| 5 | |
|---------------|-----------------------------|
| Type number | Marking code ^[1] |
| 74AUP3G0434DC | pZ |
| 74AUP3G0434GT | pZ |
| 74AUP3G0434GF | pZ |
| 74AUP3G0434GD | pZ |
| 74AUP3G0434GM | pZ |
| 74AUP3G0434GN | pZ |
| 74AUP3G0434GS | pZ |
| | |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

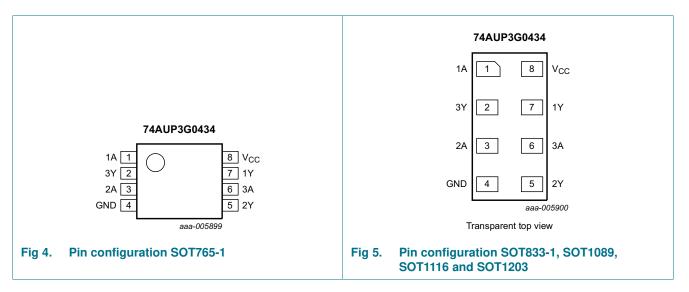
Low-power dual inverter and single buffer

5. Functional diagram

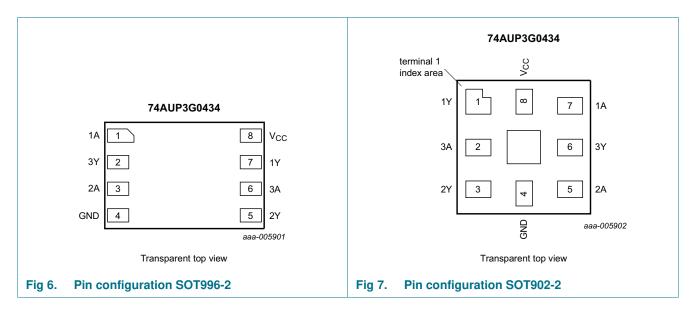


6. Pinning information

6.1 Pinning



Low-power dual inverter and single buffer



6.2 Pin description

| Table 3.PinSymbol | n description Pin | Description | |
|-------------------|---|-------------|----------------|
| | SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203 | SOT902-2 | |
| 1A, 2A, 3A | 1, 3, 6 | 7, 5, 2 | data input |
| 1Y, 2Y, 3Y | 7, 5, 2 | 1, 3, 6 | data output |
| GND | 4 | 4 | ground (0 V) |
| V _{CC} | 8 | 8 | supply voltage |

7. Functional description

Table 4. Function table^[1]

| Input 1A,3A | Output |
|----------------|--------|
| 1A,3A | 1Y, 3Y |
| L | Н |
| Н | L |

[1] H = HIGH voltage level; L = LOW voltage level.

Table 5.Function table

| Input | Output |
|-------|--------|
| 2A | 2Y |
| L | L |
| Н | Н |

[1] H = HIGH voltage level; L = LOW voltage level.

Low-power dual inverter and single buffer

8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| | | | | 10 | , |
|------------------|-------------------------|---------------------------------|---------------|------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V _{CC} | supply voltage | | -0.5 | +4.6 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| VI | input voltage | | <u>1</u> –0.5 | +4.6 | V |
| I _{OK} | output clamping current | V _O < 0 V | -50 | - | mA |
| Vo | output voltage | Active mode and Power-down mode | <u>1</u> –0.5 | +4.6 | V |
| lo | output current | $V_{O} = 0 V$ to V_{CC} | - | ±20 | mA |
| I _{CC} | supply current | | - | 50 | mA |
| I _{GND} | ground current | | -50 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40$ °C to +125 °C | [2] _ | 250 | mW |
| | | | | | |

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For VSSOP8 packages: above 110 °C the value of Ptot derates linearly with 8.0 mW/K.

For XSON8 and XQFN8 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 7.Operating conditions

| | · · | | | | |
|-----------------------|-------------------------------------|---------------------------------|-----|-----------------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V _{CC} | supply voltage | | 0.8 | 3.6 | V |
| VI | input voltage | | 0 | 3.6 | V |
| Vo | output voltage | Active mode | 0 | V _{CC} | V |
| | | Power-down mode; $V_{CC} = 0 V$ | 0 | 3.6 | V |
| T _{amb} | ambient temperature | | -40 | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall rate | $V_{CC} = 0.8 V$ to 3.6 V | - | 200 | ns/V |

Low-power dual inverter and single buffer

10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| | 00 | | | | | Unit |
|--------------------|--|--|---------------------|-----|--|------|
| | | | | | | |
| V _{IL} L | HIGH-level input voltage | $V_{CC} = 0.8 V$ | 0.70V _{CC} | - | - | V |
| V _{IL} L | HIGH-level input voltage LOW-level input voltage HIGH-level output voltage LOW-level output voltage LOW-level output voltage | $V_{CC} = 0.9 V$ to 1.95 V | 0.65V _{CC} | - | - | V |
| V _{IL} L | | V_{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| V _{IL} L | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | 2.0 | - | - | V |
| | _OW-level input voltage | $V_{CC} = 0.8 V$ | - | - | $0.30V_{CC}$ | V |
| | | $V_{CC} = 0.9 V$ to 1.95 V | - | - | $0.35V_{CC}$ | V |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.30V _{CC} 0.35V _{CC} 0.7 0.9 - - - - - - - - - - - - - - - - - - - | V |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | - | - | 0.9 | V |
| V _{OH} F | HIGH-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I_O = $-20~\mu\text{A};~V_{CC}$ = 0.8 V to 3.6 V | $V_{CC}-0.1$ | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | 0.75V _{CC} | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 1.11 | - | - 0.30V _{CC} 0.35V _{CC} 0.7 0.9 - - - - - - - - - - - - - - 0.1 0.3V _{CC} 0.31 | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.32 | - | - | V |
| | | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 2.05 | - | - - - 0.1 | V |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.72 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.6 | - | - | V |
| V _{OL} L | LOW-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I_O = 20 $\mu A;V_{CC}$ = 0.8 V to 3.6 V | - | - | | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | - | - | | V |
| | | $I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.31 | V |
| | | I _O = 1.9 mA; V _{CC} = 1.65 V | - | - | 0.31 | V |
| | | I_{O} = 2.3 mA; V_{CC} = 2.3 V | - | - | 0.31 | V |
| | | $I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.44 | V |
| | | I_{O} = 2.7 mA; V_{CC} = 3.0 V | - | - | 0.31 | V |
| | | $I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.44 | V |
| ı ir | nput leakage current | $V_{\rm I}$ = GND to 3.6 V; $V_{\rm CC}$ = 0 V to 3.6 V | - | - | ±0.1 | μA |
| l _{off} p | oower-off leakage current | V_{I} or V_{O} = 0 V to 3.6 V; V_{CC} = 0 V | - | - | ±0.2 | μA |
| | | $V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$ | - | - | ±0.2 | μA |
| cc s | supply current | $\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \ to \ 3.6 \ V \end{array}$ | - | - | 0.5 | μA |
| ∆l _{CC} a | additional supply current | | - | - | 40 | μA |
| C _I ir | nput capacitance | $V_{CC} = 0$ V to 3.6 V; $V_I = GND$ or V_{CC} | - | 1.0 | - | pF |
| | output capacitance | $V_{O} = GND; V_{CC} = 0 V$ | - | 1.8 | - | pF |

Low-power dual inverter and single buffer

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|---------------------------|---|---------------------|-----|--|------|
| T _{amb} = - | 40 °C to +85 °C | | | | | |
| V _{IH} | HIGH-level input voltage | $V_{CC} = 0.8 V$ | 0.70V _{CC} | - | - | V |
| | LOW-level input voltage | $V_{CC} = 0.9 V$ to 1.95 V | 0.65V _{CC} | - | - | V |
| | | V_{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | 2.0 | - | Max - - - 0.30V _{CC} 0.35V _{CC} 0.7 0.9 - - 0.35V _{CC} 0.7 0.9 - - - - - - - - - 0.1 0.3V _{CC} 0.37 0.33 0.45 0.33 0.45 ±0.5 ±0.6 0.9 50 | V |
| V _{IL} | LOW-level input voltage | $V_{CC} = 0.8 V$ | - | - | $0.30V_{CC}$ | V |
| | | $V_{CC} = 0.9 V$ to 1.95 V | - | - | $0.35V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | - | 0.7 | V |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | - | - | 0.9 | V |
| V _{OH} | HIGH-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I_{O} = –20 $\mu A; V_{CC}$ = 0.8 V to 3.6 V | $V_{CC}-0.1$ | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | 0.7V _{CC} | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 1.03 | - | - | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.30 | - | - | V |
| | | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.97 | - | - | V |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.85 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.67 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.55 | - | - | V |
| V _{OL} | LOW-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I_O = 20 $\mu A;V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | - | - | $0.3V_{CC}$ | V |
| | | $I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.37 | V |
| | | I _O = 1.9 mA; V _{CC} = 1.65 V | - | - | 0.35 | V |
| | | $I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.33 | V |
| | | $I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.45 | V |
| | | $I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.33 | V |
| | | $I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.45 | V |
| I | input leakage current | $V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V | - | - | ±0.5 | μA |
| OFF | power-off leakage current | V_{I} or V_{O} = 0 V to 3.6 V; V_{CC} = 0 V | - | - | ±0.5 | μA |
| ∆I _{OFF} | | $ V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V}; $ | - | - | ±0.6 | μA |
| СС | supply current | $\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \text{ to } 3.6 \ V \end{array}$ | - | - | 0.9 | μA |
| ∆I _{CC} | additional supply current | | - | - | 50 | μA |

Table 8. Static characteristics ... continued

74AUP3G0434 **Product data sheet**

Low-power dual inverter and single buffer

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|---|--|------------------------|-----|--------------|------|
| T _{amb} = – | 40 °C to +125 °C | | | | | |
| V _{IH} | HIGH-level input voltage | $V_{CC} = 0.8 V$ | $0.75V_{CC}$ | - | - | V |
| | | $V_{CC} = 0.9 V$ to 1.95 V | $0.70V_{CC}$ | - | - | V |
| | | V_{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | $V_{CC} = 3.0 V \text{ to } 3.6 V$ | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | $V_{CC} = 0.8 V$ | - | - | $0.25V_{CC}$ | V |
| | | $V_{CC} = 0.9 V$ to 1.95 V | - | - | $0.30V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | - | 0.7 | V |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | - | - | 0.9 | V |
| V _{он} | HIGH-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I_O = –20 $\mu A; V_{CC}$ = 0.8 V to 3.6 V | V _{CC} - 0.11 | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | 0.6V _{CC} | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 0.93 | - | - | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.17 | - | - | V |
| | | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.77 | - | - | V |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.67 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.40 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.30 | - | - | V |
| V _{OL} | LOW-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I_O = 20 $\mu A;V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.11 | V |
| | | $I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.33V_{CC}$ | V |
| | | $I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.41 | V |
| | | $I_{O} = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.39 | V |
| | | $I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.36 | V |
| | | $I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.50 | V |
| | | $I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.36 | V |
| | | $I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.50 | V |
| I | input leakage current | $V_{\rm I}=GND$ to 3.6 V; $V_{\rm CC}=0$ V to 3.6 V | - | - | ±0.75 | μA |
| OFF | power-off leakage current | $V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$ | - | - | ±0.75 | μA |
| ∆I _{OFF} | additional power-off leakage current | $ V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V}; $ | - | - | ±0.75 | μA |
| СС | supply current | $\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ \text{A}; \\ V_{CC} = 0.8 \ \text{V to } 3.6 \ \text{V} \end{array}$ | - | - | 1.4 | μA |
| ∆I _{CC} | additional supply current | | - | - | 75 | μA |

Table 8. Static characteristics ... continued

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Low-power dual inverter and single buffer

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

| Symbol | Parameter | Conditions | | 25 °C | | –40 °C to +125 °C | | | Unit |
|-----------------------------------|-------------------|--|-----------|--------|------|-------------------|----------------|-----------------|------|
| | | | Min | Typ[1] | Max | Min | Max (85 °C) | Max (125 °C) | |
| C _L = 5 p | F | | | | | | | 1 | |
| pd | propagation delay | nA to nY; see Figure 8 | <u>1</u> | | | | | | |
| | | $V_{CC} = 0.8 V$ | - | 16.0 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | 2.4 | 5.0 | 10.3 | 2.0 | 11.4 | 12.6 | ns |
| | | $V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$ | 1.8 | 3.6 | 6.4 | 1.6 | 7.4 | 8.2 | ns |
| | | $V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$ | 1.5 | 2.9 | 5.0 | 1.4 | 5.9 | 6.5 | ns |
| | | $V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$ | 1.2 | 2.4 | 3.9 | 1.1 | 4.5 | 5.0 | ns |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | 1.1 | 2.1 | 3.2 | 1.0 | 3.9 | 4.3 | ns |
| C _L = 10 | pF | | | | | | | | |
| t _{pd} propagation delay | propagation delay | nA to nY; see Figure 8 | 1 | | | | | | |
| | $V_{CC} = 0.8 V$ | - | 19.8 | - | - | - | - | ns | |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | 2.8 | 5.9 | 12.2 | 2.3 | 13.7 | 15.1 | ns |
| | | $V_{CC} = 1.4 V$ to 1.6 V | 2.3 | 4.2 | 7.5 | 1.9 | 8.7 | 9.6 | ns |
| | | $V_{CC} = 1.65 \text{ V}$ to 1.95 V | 2.0 | 3.5 | 5.9 | 1.7 | 7.0 | 7.7 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | 1.7 | 2.9 | 4.6 | 1.5 | 5.4 | 6.0 | ns |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | 1.6 | 2.7 | 3.8 | 1.4 | 4.5 | 5.1 | ns |
| C _L = 15 | pF | | | | | | | | |
| pd | propagation delay | nA to nY; see Figure 8 | 1 | | | | | | |
| | | $V_{CC} = 0.8 V$ | - | 23.3 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | 3.2 | 6.7 | 13.0 | 2.6 | 15.8 | 17.4 | ns |
| | | $V_{CC} = 1.4 V$ to 1.6 V | 2.6 | 4.7 | 8.6 | 2.2 | 10.0 | 11.0 | ns |
| | | $V_{CC} = 1.65 \text{ V}$ to 1.95 V | 2.3 | 4.0 | 6.7 | 2.0 | 8.0 | 8.8 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | 2.1 | 3.3 | 5.1 | 1.8 | 6.1 | 6.8 | ns |
| | | $V_{CC} = 3.0 V$ to 3.6 V | 2.0 | 3.1 | 4.2 | 1.6 | 5.0 | 5.5 | ns |
| C _L = 30 | pF | | | | | | | | |
| pd | propagation delay | nA to nY; see Figure 8 | <u>!]</u> | | | | | | |
| | | $V_{CC} = 0.8 V$ | - | 33.6 | - | - | - | - | ns |
| | | V _{CC} = 1.1 V to 1.3 V | 4.4 | 8.9 | 16.3 | 3.6 | 19.0 | 20.9 | ns |
| | | $V_{CC} = 1.4 V$ to 1.6 V | 3.6 | 6.3 | 10.8 | 3.2 | 12.9 | 14.2 | ns |
| | | $V_{CC} = 1.65 \text{ V}$ to 1.95 V | 3.2 | 5.3 | 9.0 | 2.9 | 10.5 | 11.6 | ns |
| | | $V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$ | 2.9 | 4.5 | 6.5 | 2.6 | 7.6 | 8.5 | ns |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | 2.9 | 4.2 | 5.6 | 2.5 | 6.2 | 7.2 | ns |
| | | | | | | | | | |

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| Symbol | Parameter | Conditions | 25 °C | | –40 °C to +125 °C | | | Unit | |
|-----------------------|----------------------------------|--|-------|--------|-------------------|-----|----------------|-----------------|----|
| | | | Min | Typ[1] | Мах | Min | Max (85 °C) | Max (125 °C) | |
| C _L = 5 pl | F, 10 pF, 15 pF and | 30 pF | | | | | | | |
| C _{PD} | power dissipation capacitance | $f_i = 1 \text{ MHz}; V_1 = \text{GND to } V_{\text{CC}}$ [3][4] | | | | | | | |
| | | $V_{CC} = 0.8 V$ | - | 2.5 | - | - | - | - | pF |
| | | V _{CC} = 1.1 V to 1.3 V | - | 2.7 | - | - | - | - | pF |
| | | $V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$ | - | 2.8 | - | - | - | - | pF |
| | | V _{CC} = 1.65 V to 1.95 V | - | 3.0 | - | - | - | - | pF |
| | | $V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$ | - | 3.5 | - | - | - | - | pF |
| | | V _{CC} = 3.0 V to 3.6 V | - | 4.0 | - | - | - | - | pF |

Table 9. Dynamic characteristics ... continued

[1] All typical values are measured at nominal V_{CC}.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] All specified values are the average typical values over all stated loads.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = input frequency in MHz;$

 f_0 = output frequency in MHz;

 C_L = load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

12. Waveforms

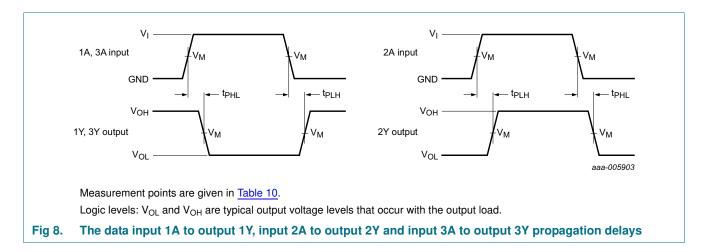


Table 10. Measurement points

| Supply voltage | Output | Input | | |
|-----------------|--------------------|--------------------|-----------------|---------------------------------|
| V _{CC} | V _M | V _M | VI | t _r = t _f |
| 0.8 V to 3.6 V | 0.5V _{CC} | 0.5V _{CC} | V _{CC} | \leq 3.0 ns |

| 74AUP3G0434 | |
|--------------------|--|
| Product data sheet | |

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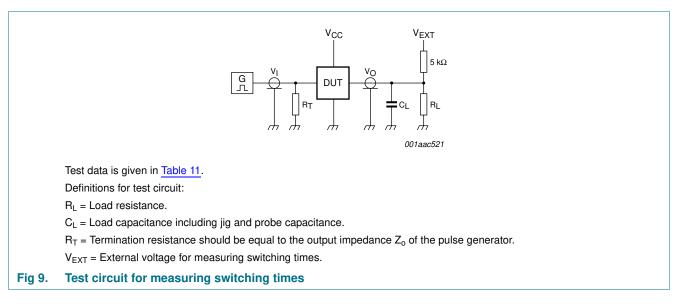


Table 11. Test data

| Supply voltage | Load | | V _{EXT} | | |
|-----------------|-------------------------------|------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| V _{CC} | CL | R _L [1] | t _{PLH} , t _{PHL} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} |
| 0.8 V to 3.6 V | 5 pF, 10 pF, 15 pF, and 30 pF | 5 k Ω or 1 M Ω | open | GND | 2V _{CC} |

[1] For measuring enable and disable times, $R_L = 5 k\Omega$.

For measuring propagation delays, setup and hold times, and pulse width, $R_L = 1 M\Omega$.

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13. Package outline

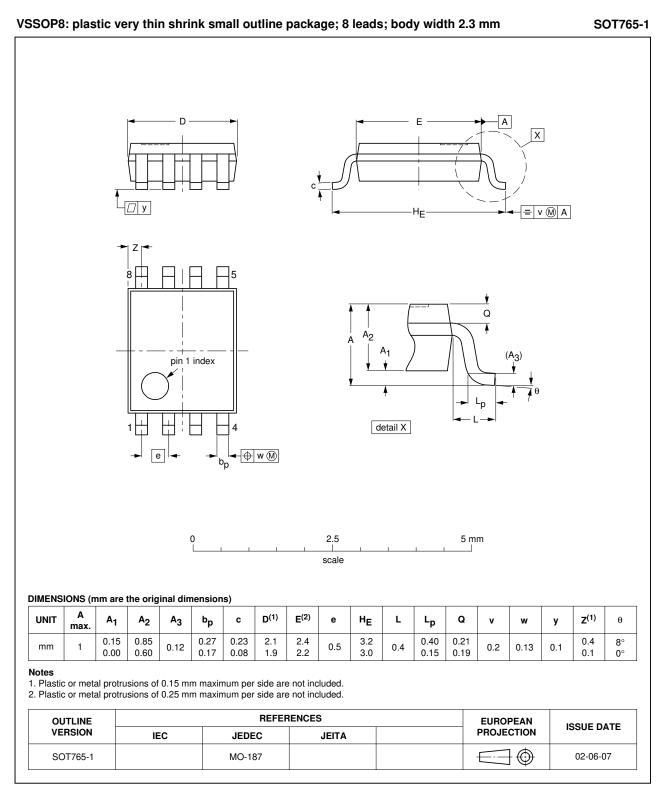


Fig 10. Package outline SOT765-1 (VSSOP8)

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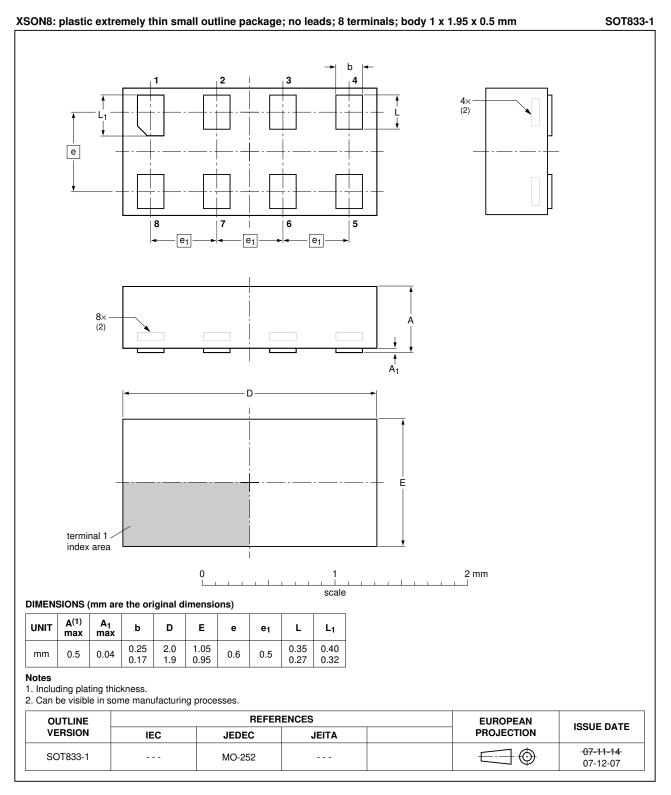
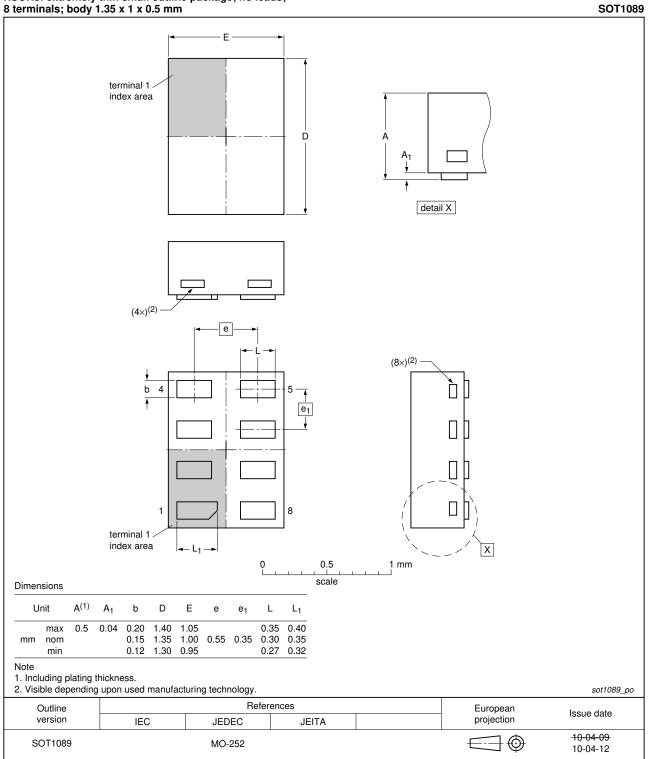


Fig 11. Package outline SOT833-1 (XSON8)

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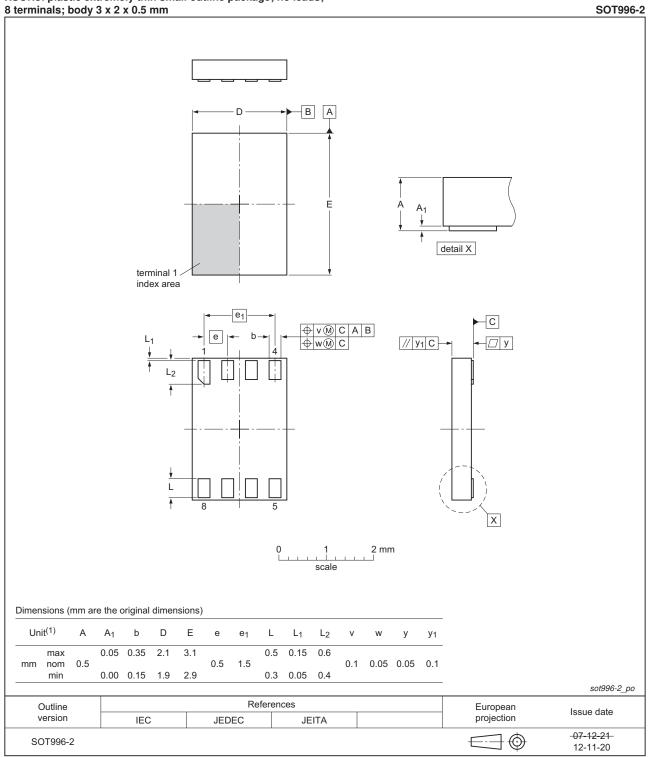


XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm

Fig 12. Package outline SOT1089 (XSON8)

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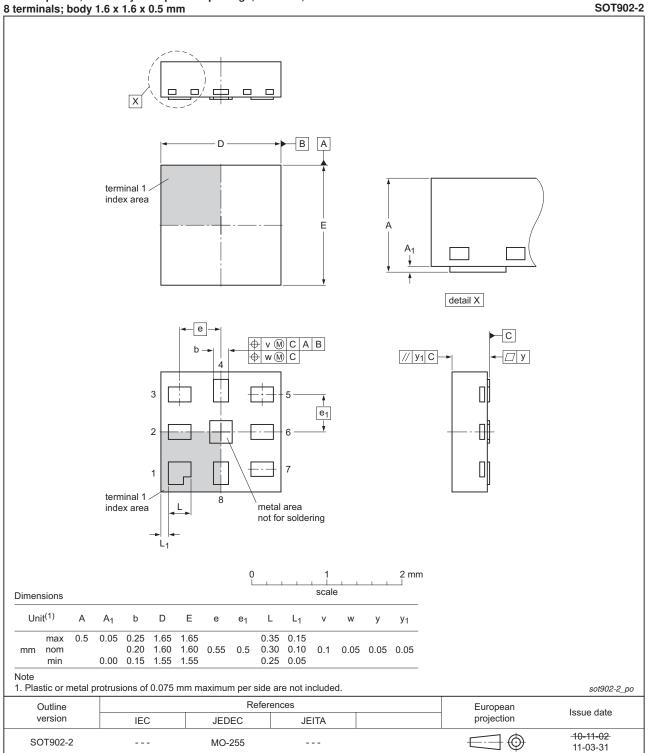


XSON8: plastic extremely thin small outline package; no leads;

Fig 13. Package outline SOT996-2 (XSON8)

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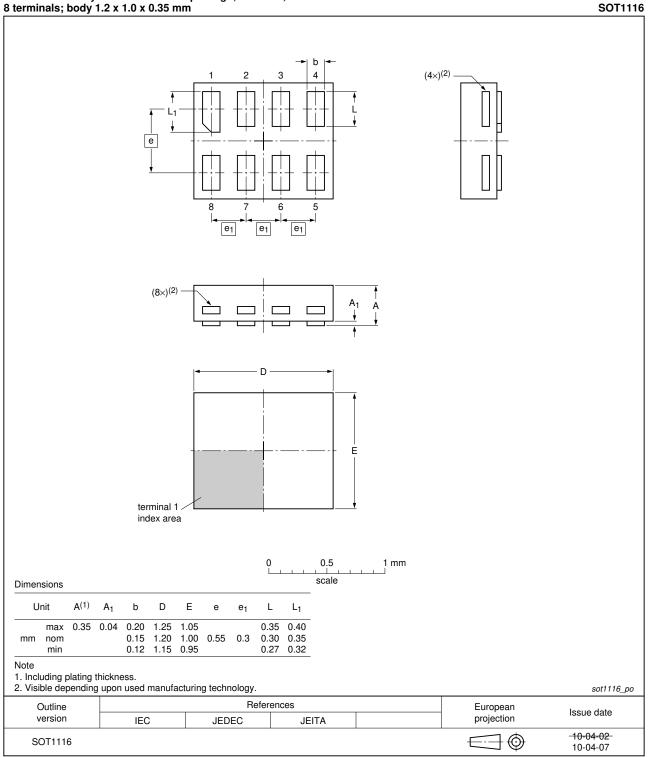


XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm

Fig 14. Package outline SOT902-2 (XQFN8)

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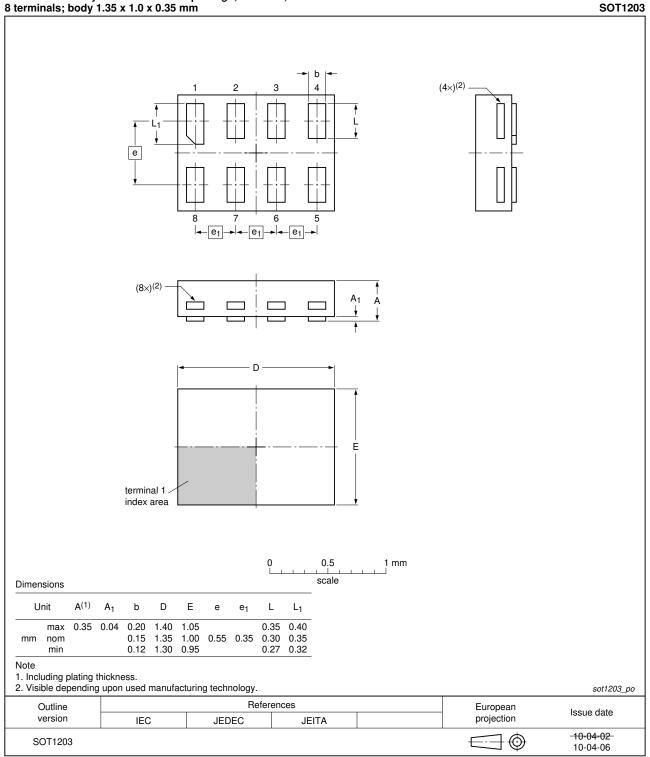


XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm

Fig 15. Package outline SOT1116 (XSON8)

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XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm

Fig 16. Package outline SOT1203 (XSON8)

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14. Abbreviations

| Acronym | Description | |
|---------|-------------------------|--|
| | | |
| CDM | Charged Device Model | |
| DUT | Device Under Test | |
| ESD | ElectroStatic Discharge | |
| HBM | Human Body Model | |
| MM | Machine Model | |

15. Revision history

Table 13.Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
|-----------------|--|--------------------|---------------|-----------------|--|--|
| 74AUP3G0434 v.2 | 20130117 | Product data sheet | - | 74AUP3G0434 v.1 | | |
| Modifications: | For type number 74AUP3G0434GD XSON8U has changed to XSON8. | | | | | |
| 74AUP3G0434 v.1 | 20121217 | Product data sheet | - | - | | |

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16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Date of release: 17 January 2013 Document identifier: 74AUP3G0434